

Description

The TD816 series combine an AlGaAs infrared emitting diode as the emitter which is optically coupled to a silicon planar phototransistor detector in a plastic DIP4 package with different lead forming options.

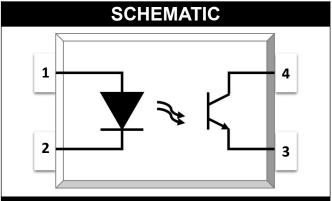
With the robust coplanar double mold structure, TD816 series provide the most stable isolation feature.

Features

- High isolation 5000 VRMS
- CTR flexibility available see order information
- DC input with transistor output
- Operating temperature range 55 °C to 110 °C
- REACH compliance
- Halogen free
- MSL class 1
- Regulatory Approvals
 - UL UL1577
 - VDE EN60747-5-5(VDE0884-5)
 - CQC GB4943.1, GB8898
 - cUL- CSA Component Acceptance
 Service Notice No. 5A

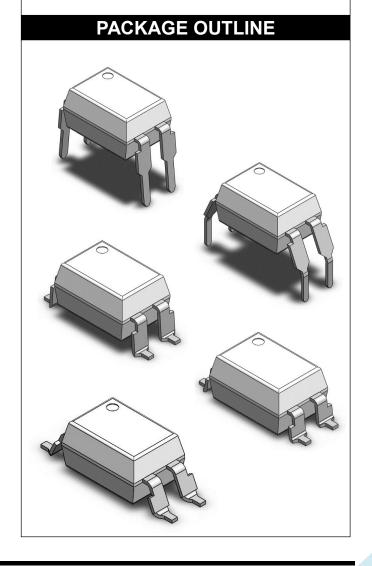
Applications

- Switch mode power supplies
- Programmable controllers
- Household appliances
- Office equipment



PIN DEFINITION

- 1. Anode
- 2. Cathode
- 3. Emitter
- 4. Collector





ABSOLUTE MAXIMUM RATINGS							
PARAMETER	SYMBOL	VALUE	UNIT	NOTE			
INPUT							
Forward Current	I _F	60	mA				
Peak Forward Current	I _{FP}	1	Α	1			
Reverse Voltage	V _R	6	V				
Input Power Dissipation	Pı	100	mW				
OUTPUT							
Collector - Emitter Voltage	V _{CEO}	80	V				
Emitter - Collector Voltage	V _{ECO}	6	V				
Collector Current	Ic	50	mA				
Output Power Dissipation	Po	150	mW				
COMMON							
Total Power Dissipation	Ptot	200	mW				
Isolation Voltage	Viso	5000	Vrms	2			
Operating Temperature	Topr	-55~110	°C				
Storage Temperature	Tstg	-55~125	°C				
Soldering Temperature	Tsol	260	°C				

Note 1. 100µs pulse, 100Hz frequency

Note 2. AC For 1 Minute, R.H. = $40 \sim 60\%$



	ELECTI	RICAL O	PTICA	L CHA	ARAC	TER	ISTICS at Ta=25°C		
PARAMETER		SYMBOL	MIN	TYP.	MAX.	UNIT	TEST CONDITION	NOTE	
				INF	UT				
Forward \	Forward Voltage		-	1.24	1.4	V	IF=10mA		
Reverse Current		I _R	-	-	10	μA	VR=6V		
Input Capa	Input Capacitance		-	10	_	pF	V=0, f=1kHz		
				OUT	PUT				
Collector Da	rk Current	I _{CEO}	-	-	100	nA	VCE=20V, IF=0		
Collector- Breakdown		BV _{CEO}	80	-	-	V	IC=0.1mA, IF=0		
Emitter-Construction Breakdown		BV _{ECO}	6	-	-	V	IE=0.1mA, IF=0		
TRANSFER CHARACTERISTICS									
	TD816		50	-	600				
	TD816A	CTR	80	-	160	%			
Current Transfer	TD816B		130	-	260		" IF=5mA, VCE=5\	IE-5m/\ \/CE-5\/	
Ratio	TD816C		200	-	400			II -SIIIA, VOL-3V	
Railo	TD816D		300	-	600				
	TD816E		100	_	200				
Collector- Saturation		V _{CE(sat)}	-	0.06	0.2	V	IF=20mA, IC=1mA		
Isolation Resistance		R _{ISO}	10^12	10^14	-	Ω	DC500V, 40 ~ 60% R.H.		
Floating Capacitance		C _{IO}	-	0.4	1	pF	V=0, f=1MHz		
Response Time (Rise)		tr	-	3	18	μs	VCE=2V, IC=2mA	3	
Response T	Response Time (Fall)		-	4	18	μs	RL=100Ω	3	
Cut-off Frequency		fc	-	80	-	kHz	VCE=2V, IC=2mA RL=100Ω,-3dB	4	

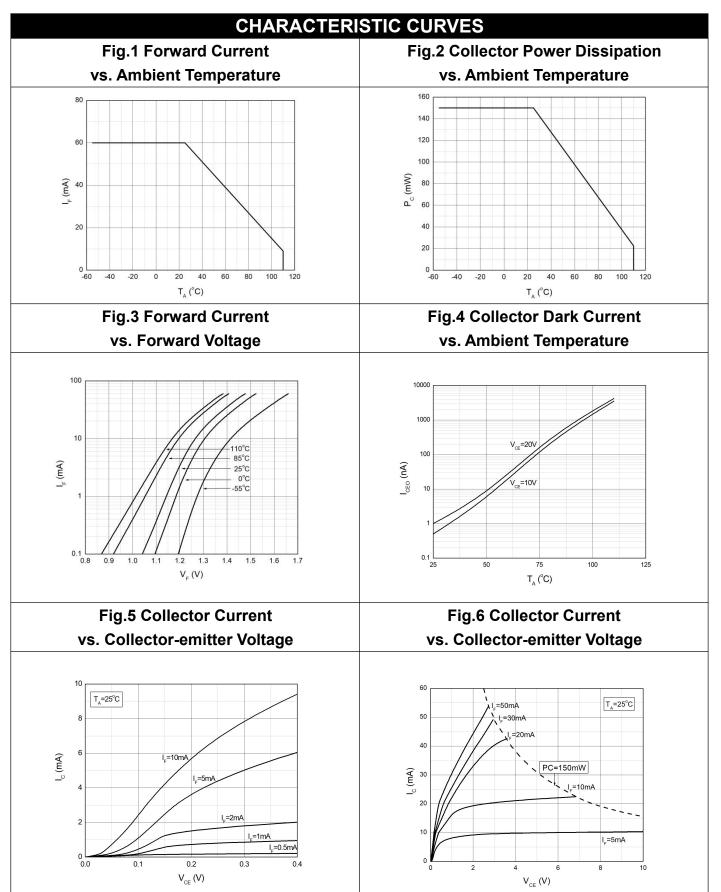
Note 3. Fig.12&13

Note 4. Fig.14



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DIP4, DC Input, Photo Transistor Coupler



Rev: A02

Release Date: 2021/6/16



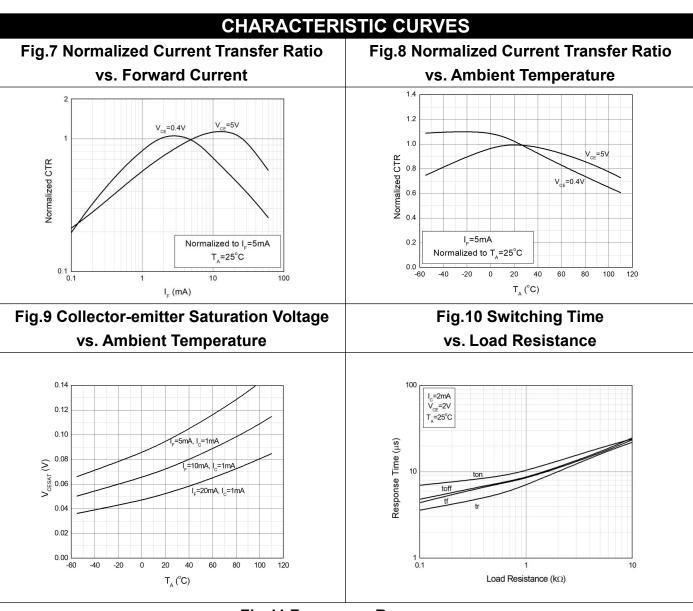
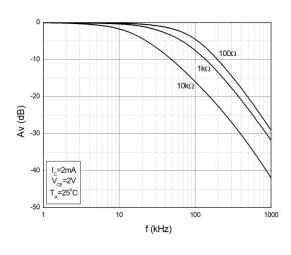
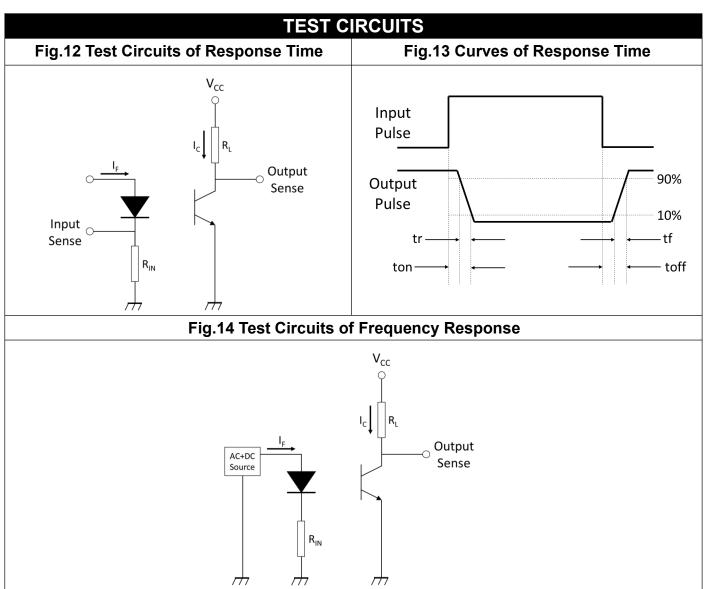


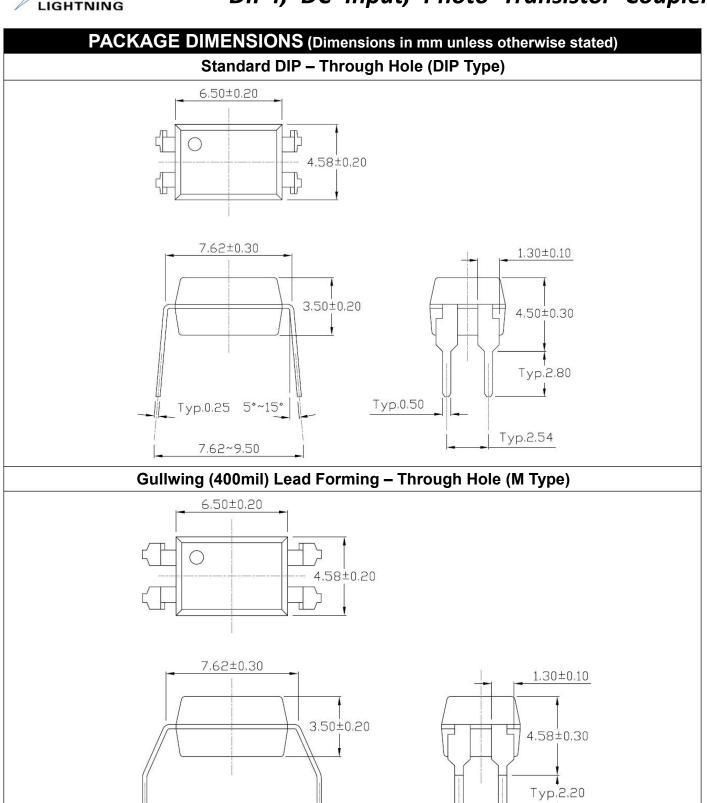
Fig.11 Frequency Response











Typ.0.50

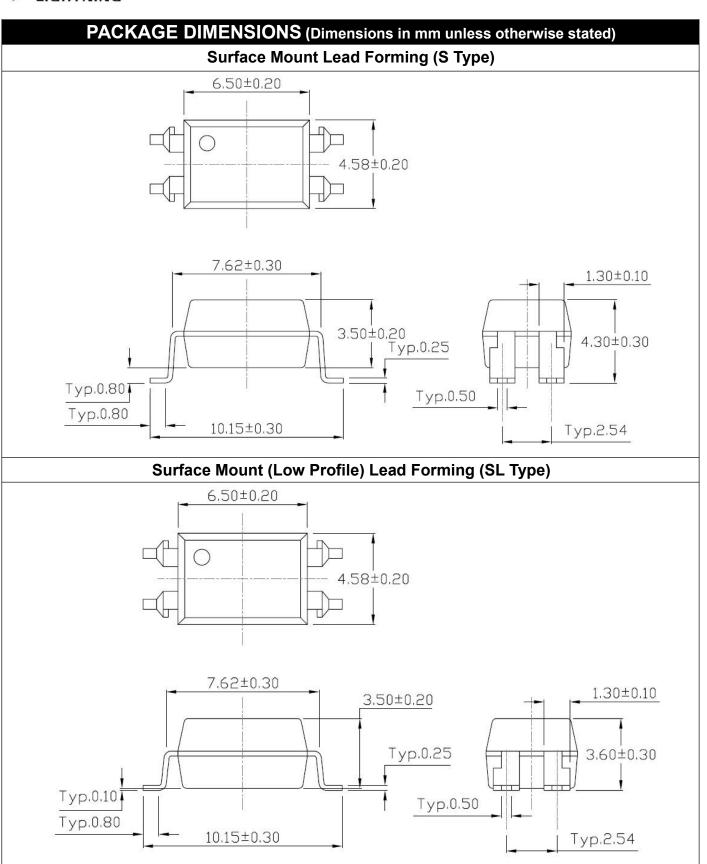
Typ.2.54

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Typ.0.25

10.16±0.30

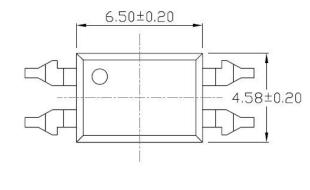


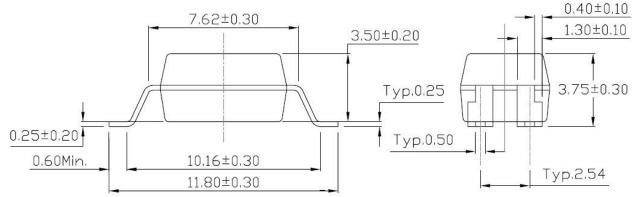




PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated)

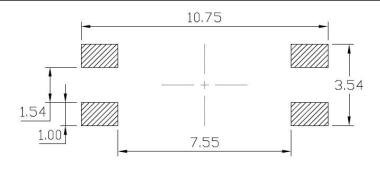
Surface Mount (Gullwing) Lead Forming (SLM Type)



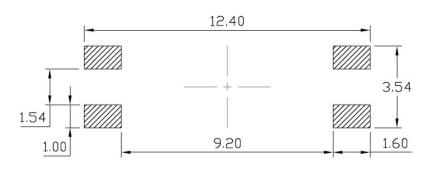


RECOMMENDED SOLDER MASK (Dimensions in mm unless otherwise stated)

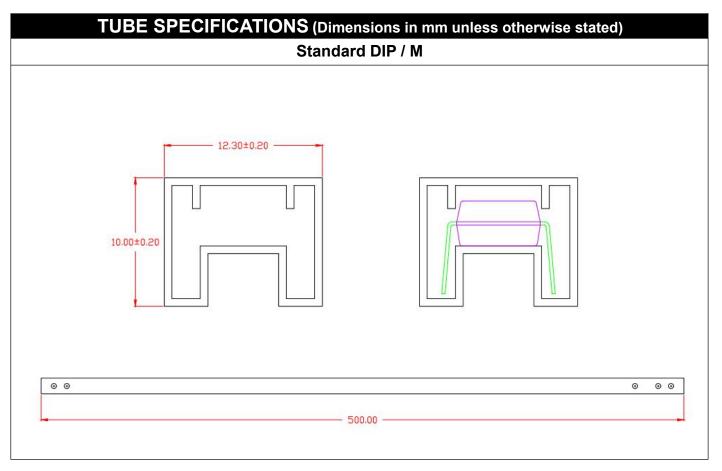
Surface Mount Lead Forming & Surface Mount (Low Profile) Lead Forming



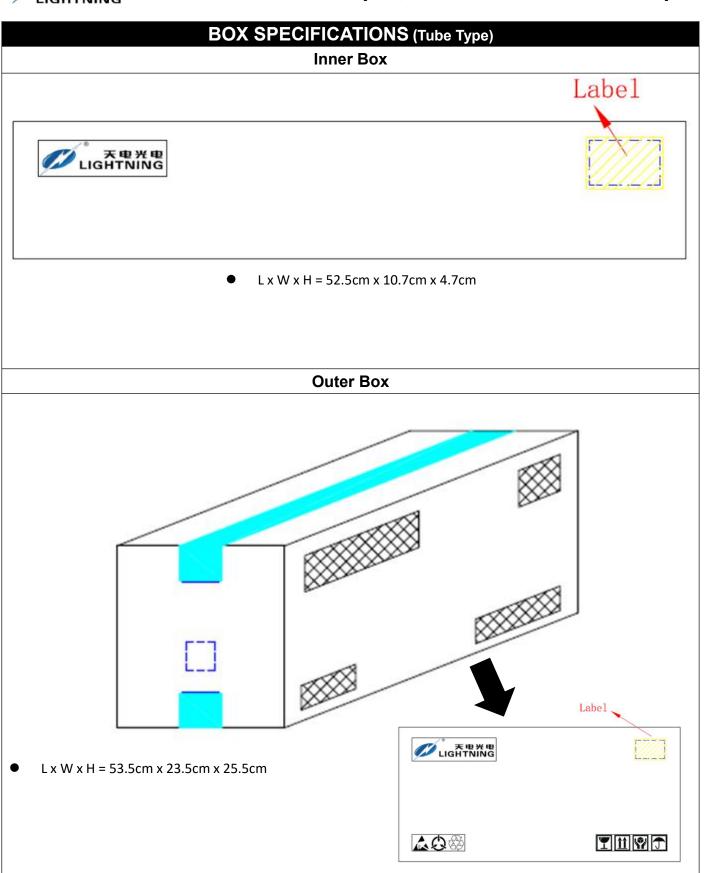
Surface Mount (Gullwing) Lead Forming







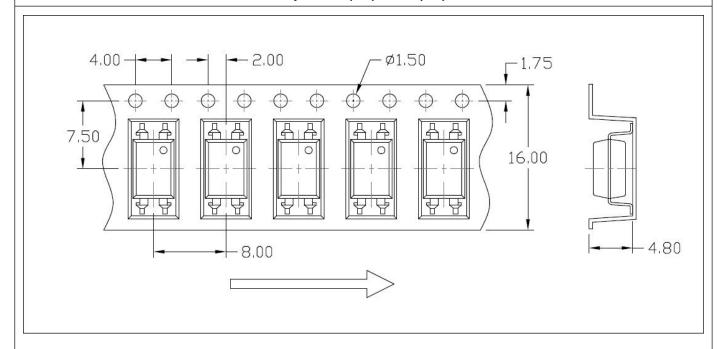




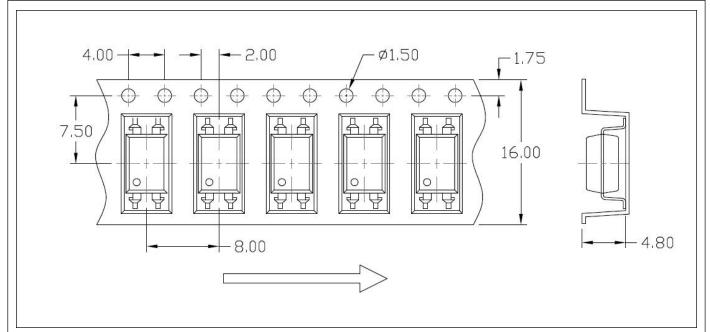


CARRIER TAPE SPECIFICATIONS (Dimensions in mm unless otherwise stated)

Option S(T1) & SL(T1)



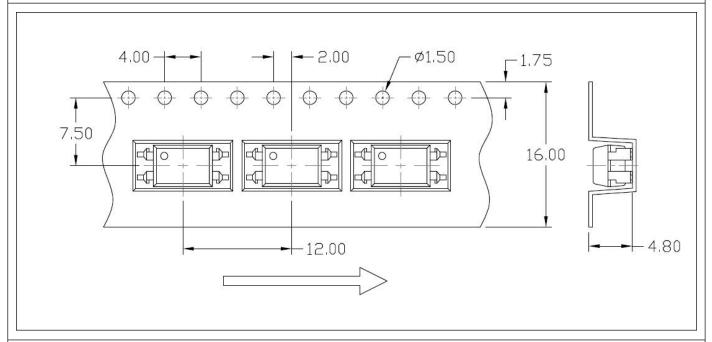
Option S(T2) & SL(T2)



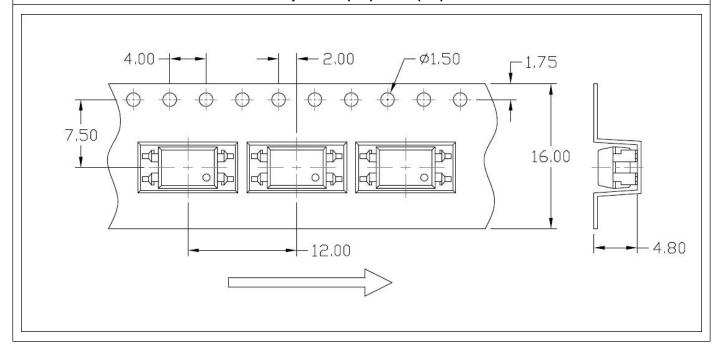


CARRIER TAPE SPECIFICATIONS (Dimensions in mm unless otherwise stated)

Option S(T3) & SL(T3)



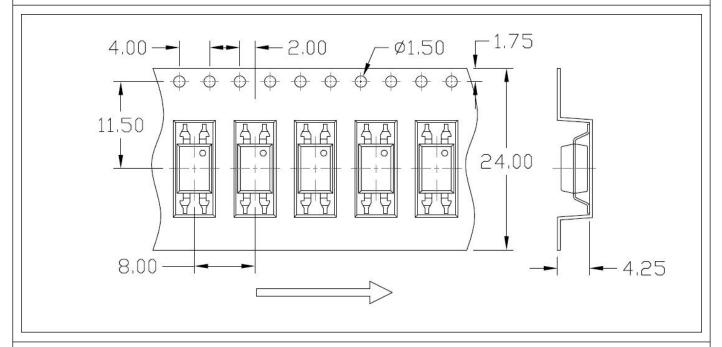
Option S(T4) & SL(T4)



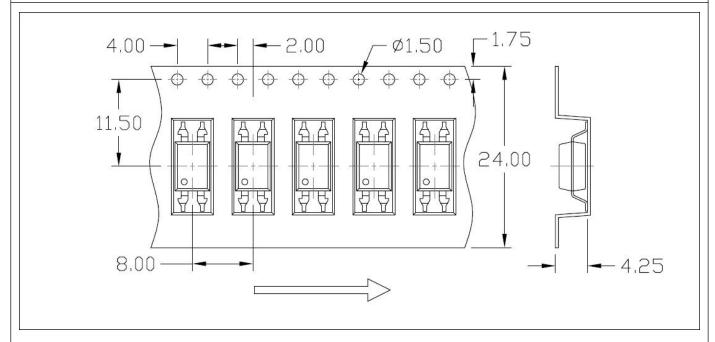


CARRIER TAPE SPECIFICATIONS (Dimensions in mm unless otherwise stated)

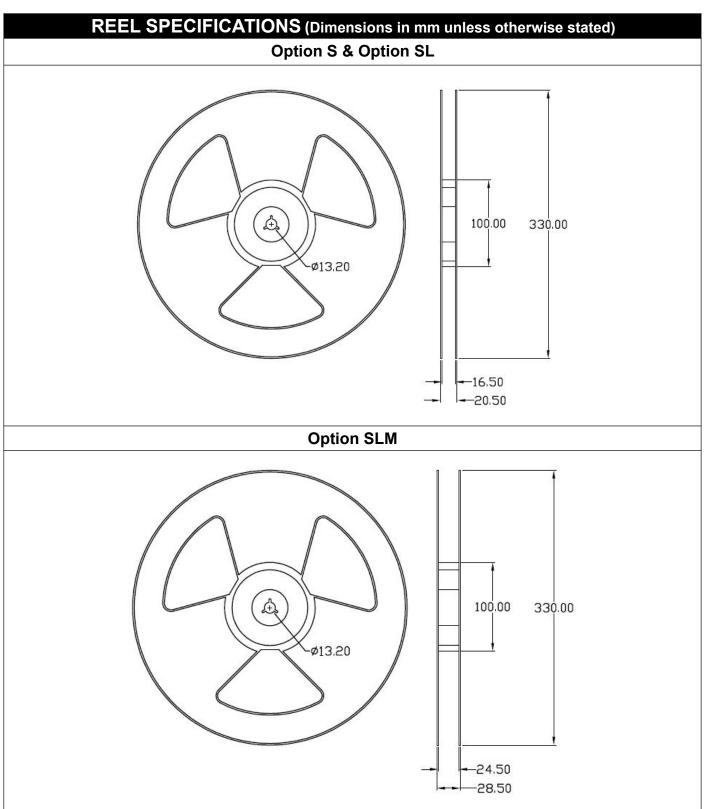
Option SLM(T1)



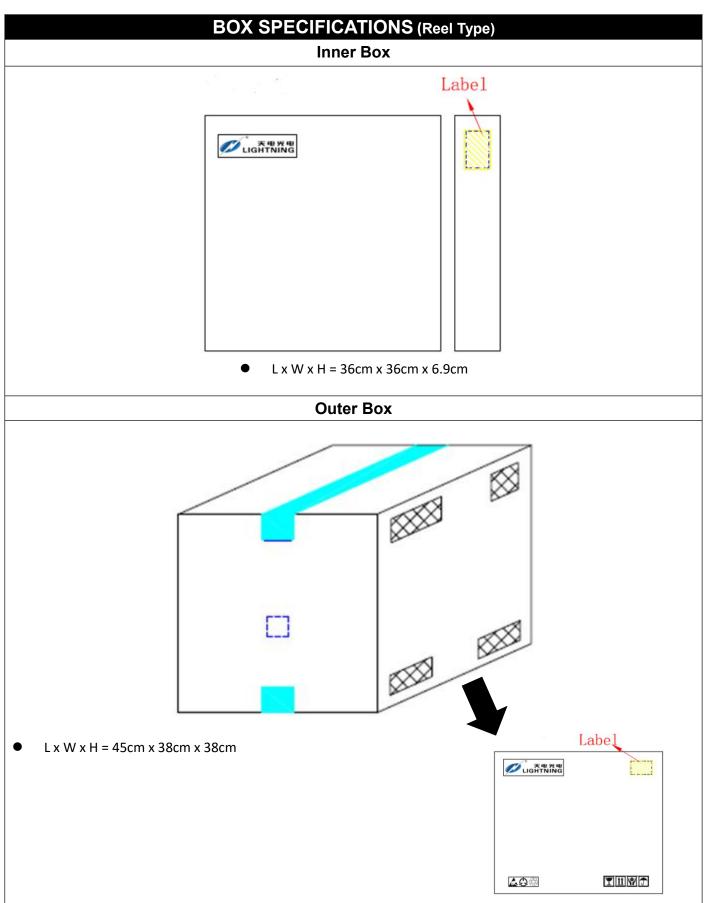
Option SLM(T2)











Release Date: 2021/6/16 Document No: DWI-003 Rev: A02



ORDERING AND MARKING INFORMATION

MARKING INFORMATION



TD : Company Abbr.

816 : Part Number

X : CTR Rank

V : VDE Option Υ : Fiscal Year

: Manufacturing Code

WW : Work Week

ORDERING INFORMATION

ORDERING INFORMATION

TD816X(Y)(Z)-GV

TD - Company Abbr.

816 - Part Number

X – Rank (A/B/C/D or None)

Y – Lead Form Option (M/S/SL/SLM/None)

Z – Tape and Reel Option (T1/T2/T3/T4)

G – Green

V – VDE Option (V or None)

LABEL INFORMATION



Part No.: XXXXXXXXX



Date Code: XXXX QTY: XXXX PCS



Made in QuanZhou FuJian



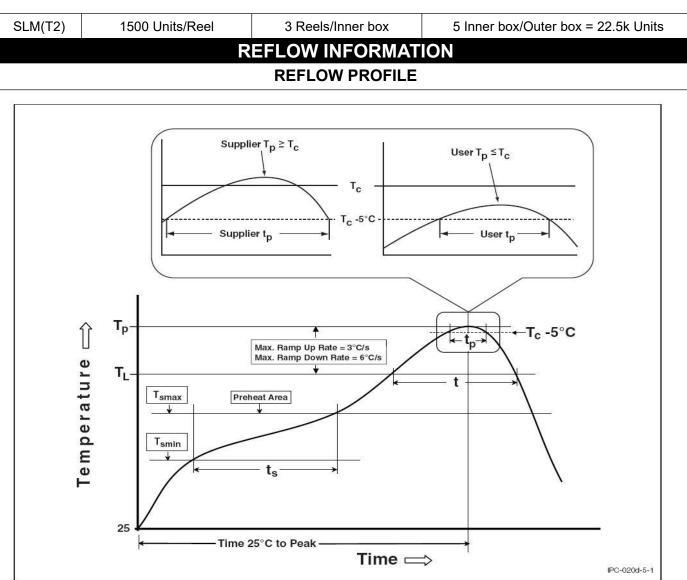




Packing Quantity

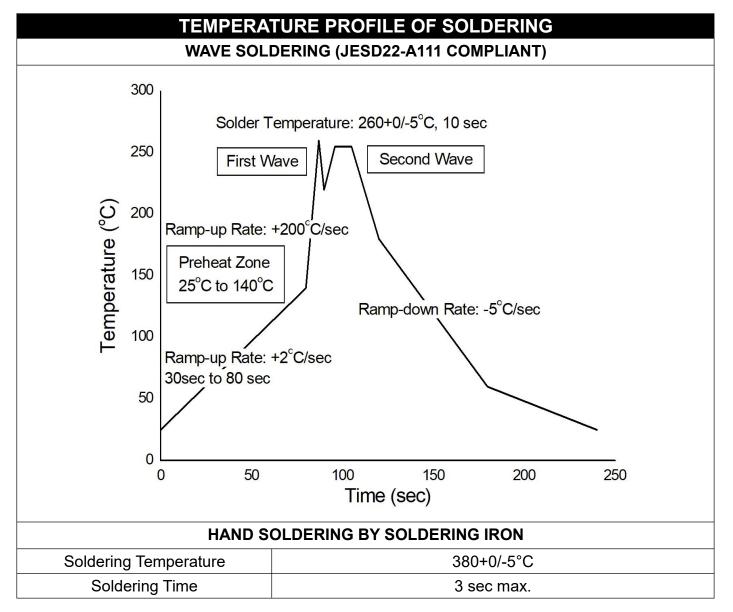
3					
Option	Quantity	Quantity – Inner box	Quantity – Outer box		
None	100 Units/Tube	32 Tubes/Inner box	10 Inner box/Outer box = 32k Units		
М	100 Units/Tube	32 Tubes/Inner box	10 Inner box/Outer box = 32k Units		
S(T1)	1500 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 22.5k Units		
S(T2)	1500 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 22.5k Units		
S(T3)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units		
S(T4)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units		
SL(T1)	1500 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 22.5k Units		
SL(T2)	1500 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 22.5k Units		
SL(T3)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units		
SL(T4)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units		
SLM(T1)	1500 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 22.5k Units		





Profile Feature	Sn-Pb Assembly Profile	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	100	150°C
Temperature Max. (Tsmax)	150	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds	60-120 seconds
Ramp-up Rate (tL to tP)	3°C/second max.	3°C/second max.
Liquidous Temperature (TL)	183°C	217°C
Time (tL) Maintained Above (TL)	60 – 150 seconds	60 – 150 seconds
Peak Body Package Temperature	235°C +0°C / -5°C	260°C +0°C / -5°C
Time (tP) within 5°C of 260°C	20 seconds	30 seconds
Ramp-down Rate (TP to TL)	6°C/second max	6°C/second max
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.





- One time soldering is recommended for all soldering method.
- Do not solder more than three times for IR reflow soldering.



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- This product is not intended to be used for military, aircraft, automotive, medical, life sustaining or lifesaving applications or any other application which can result in human injury or death.
- Please contact LIGHTNING sales agent for special application request.
- Immerge unit's body in solder paste is not recommended.
- Parameters provided in datasheets may vary in different applications and performance may vary
 over time. All operating parameters, including typical parameters, must be validated in each
 customer application by the customer's technical experts. Product specifications do not expand or
 otherwise modify LIGHTNING's terms and conditions of purchase, including but not limited to the
 warranty expressed therein.
- Discoloration might be occurred on the package surface after soldering, reflow or long-time use. It neither impacts the performance nor reliability.